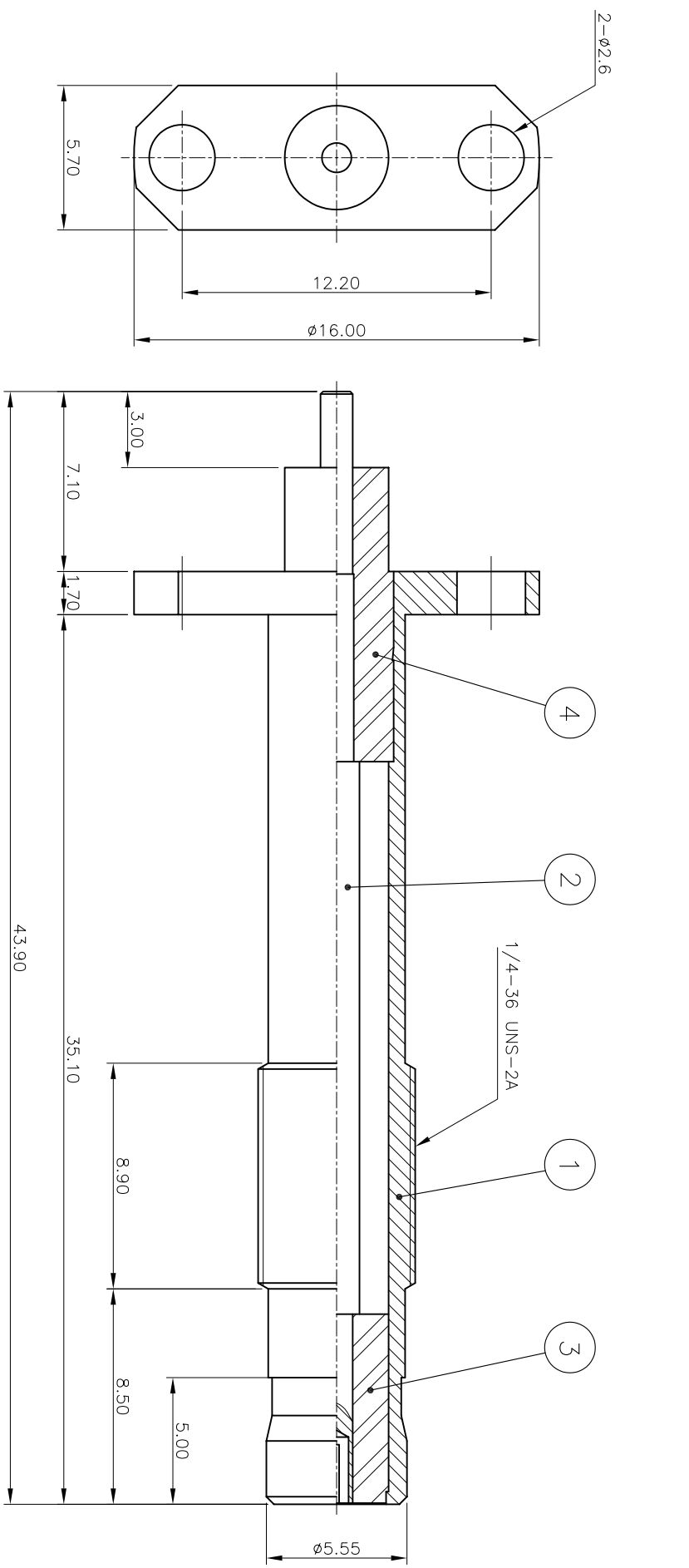


REVISION			DATE
REV	DESCRIPTION		
1	최초 개정		2009. 07. 24.



4	INSULATOR	1	TEFLON		DIN01631-N/1
3	INSULATOR	1	TEFLON		DIN01630-N/1
2	CONTACT	1	BeCu	Gold Plate	DCT02067-5/1
1	BODY	1	MBSBD	Silico Plate (3μm)	DBD02565-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE		Decimal	±0.1
Angle		±1°	
MATERIAL		-	
FINISH		-	
DATE		2009. 8. 13.	
APPROVED BY		S.J.YOUN	
CHECKED BY		I.C.KIM	
DRAWN BY		E.H.KIM	
SCALE		4/1	UNIT mm
TITLE		SMA trans(φ5.55) SOLDER END JS-2H	
DWG NO.		CN02443-7/1	
REVISION		1 R	
SHEET		1 of 1	